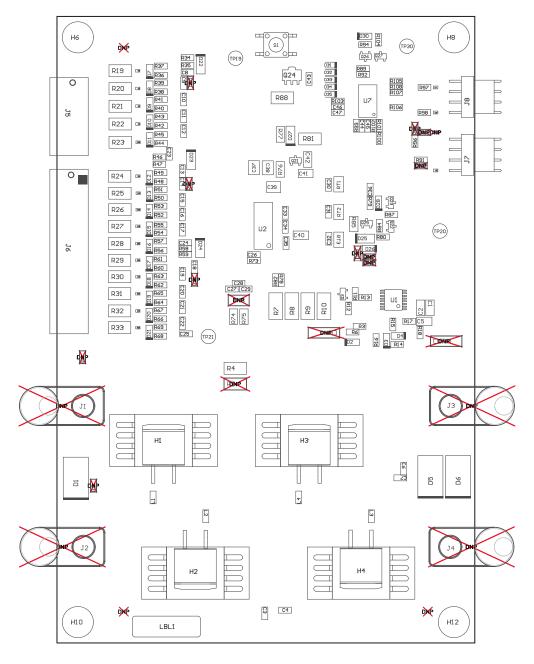
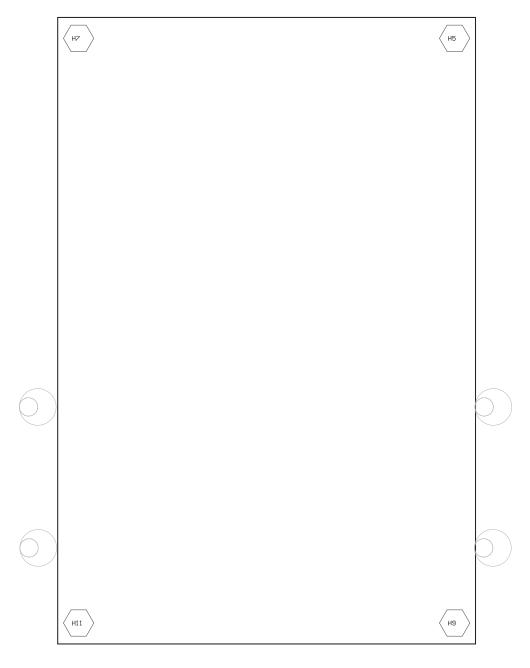
- ZZI MInstall label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ${\it ZZ2} \equiv {\it These}$ assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00792	REV: E2	SUN REU:	Not In VersionControl
	TID #: TIDA-00792			
PLOT NAME = Top Assembly Drawing	GENERATED : 3/15/201	17 12:19:39	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00792 REV: E2	SVN REV: Not In VersionControl		
	TID #: TIDA-00792			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/15/2017 12:19:4	D PM TEXAS INSTRUMENTS		

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